Application as originally filed (including Declaration, Power of Attorney and Petition)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit

: 1771

: 1//1 : A. Singh

Examiner Serial No. Filed

: A. Singn : 09/101,251

Inventors

: July 15, 1998: Soichi Ishibashi: Tetsuyuki Kyono

Title

: A MÓLDING MATERIAL AND

: A PRODUCTION PROCESS

: THEREOF

Dated: July 11, 2000

1600 Market Street

Docket: 1066-98

Philadelphia, PA 19103

36th Floor

DECLARATION OF AUSTIN R. MILLER

Assistant Commissioner for Patents Washington, DC 20231

Sir:

I, Austin R. Miller, declare that I have prepared the attached substitute specification entitled A MOLDING MATERIAL AND PRODUCTION PROCESS. This substitute specification is derived from the original Application Serial No. 09/101,251, filed July 15, 1998, and incorporates the amendments to the specification which are included in the prosecution. I hereby certify that to the best of my knowledge and belief, this substitute specification does not contain any new subject matter.

I also declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and thus such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: July 13, 2000

Austin R. Miller, Reg. No. 16,602

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	Original Application
	PCT National Application U.S. Designated Office
	Continuation or Divisional Application
	Continuation-in-Part Application
	COMBINED DECLARATION, POWER OF ATTORNEY AND PETITION
As a b	elow named inventor, I hereby declare that:
My res	sidence, post office address and citizenship are as stated below next to my name,
invento	we I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint or (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on rention entitled
\square $\hat{\mathbf{w}}$	hich is described in the specification and claims
	attached hereto.
	filed on
	Application Serial No.
	and was amended on
	(if applicable)
w w	hich is described in International Application No. PCT/JP97/04049 filed November 6, 1997 and as amended or
	(if any)

which I have reviewed and for which I solicit a United States patent.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I do not know and do not believe that this invention was ever known or used in the United States before my or our invention thereof or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application or said international application, or in public use or on sale in the United States of America more than one year prior to this application or said international application, or that the invention has been patented or made the subject of an inventor's certificate issued before the date of this application or said international application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application or said international application, or that any application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application or said international application by me or my legal representatives or assigns except as identified below.

COMBINED ECLARATION, POWER OF ATTORNE AND PETITION (Page 2)

Attorney Docket No. 1066-98

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign applications for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Number	Country	Date of Filing (day, month, year)	Priority Claimed
293633/96	Japan	06,11,96	■ yes □ no
			□ yes □ no
			□ yes □ no
			□ yes □ no
			□ yes □ no
in the prior United States ap §112, I acknowledge the du §1.56(a) which occurred bet date of this application:	ty to disclose material info	rmation as defined in Title	37, Code of Federal Regulations, national or PCT international filing
§112, I acknowledge the du §1.56(a) which occurred bet	ty to disclose material info	rmation as defined in Title	37, Code of Federal Regulations
§112, I acknowledge the du §1.56(a) which occurred bet date of this application:	ty to disclose material inforween the filing date of the p	rmation as defined in Title	37, Code of Federal Regulations, national or PCT international filing
§112, I acknowledge the du §1.56(a) which occurred bet date of this application: (Application Serial No.)	ty to disclose material informeen the filing date of the provided (Filing Date) (Filing Date) As a named inventor, I here	rmation as defined in Title rior application(s) and the r	37, Code of Federal Regulations national or PCT international filing (Status) (patented, pending, abandoned) (Status) (patented, pending, abandoned) torneys to prosecute this application

SEND CORRESPONDENCE TO: Schnader Harrison Segal & Lewis 36th Floor 1600 Market Street Philadelphia, PA 19103	DIRECT TELEPHONE CALLS TO ATTORNEY INDICATED ON PAPER: Austin R. Miller T. Daniel Christenbury Frank A. Cona David A. Sasso Patrick J. Farley (215) 563-1810
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COMBINED DECLARATION, POWER OF ATTORNEY AND PETITION (Page 3)

Attorney Docket No. 1066-98

I hereby petition for grant of a United States Letters Patent on this invention.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1. FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE DATE 7/7/98						
Soichi Ishibashi	Jachi (Ushibashi //10						
RESIDENCE	CITIZENSHIP						
Ehime Japan	Japanese						
POST OFFICE ADDRESS							
Seto-ryo, 1456, Oaza-Tsutsui, Masaki-cho, Iyo-gun, Ehime 791-31 Japan							
2. FULL NAME OF JOINT INVENTOR, IF ANY	Tetscynty Was DATE 7/2/98						
Tetsuyuki Kyono	Tetrayah Mais 12/98						
RESIDENCE	CITIZENSHIP						
Ehime Japan	Japanese						
POST OFFICE ADDRESS							
11-12-901 Iwasaki-cho 2-chome, Matsuyama-shi, Ehime 790) Japan						
3. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE DATE						
RESIDENCE	CITIZENSHIP						
POST OFFICE ADDRESS							
4. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE DATE						
RESIDENCE	CITIZENSHIP						
POST OFFICE ADDRESS							
5. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE DATE						
RESIDENCE	CITIZENSHIP						
POST OFFICE ADDRESS							
6. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE DATE						
RESIDENCE	CITIZENSHIP .						
POST OFFICE ADDRESS							
7. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY	INVENTOR'S SIGNATURE DATE						
RESIDENCE	CITIZENSHIP						
POST OFFICE ADDRESS							